Wong Tsz Ho
黃子豪

✉ : cenz@engineer.com

📞 : +852 6158 5094

👤 : Cenz

in : linkedin.com/in/CenzWong

🌐 : cenzwong.github.io

Education:

The Hong Kong University of Science and Technology [2020 – 2022*]

planned

MSc in Big Data Technology

- Apache Spark
- Time Series Analysis
- Data Analytics Techniques
- Parallel Programming

The Hong Kong Polytechnic University [2015 – 2020]

BEng(Hons) in Electronic and Information Engineering, [WGPA : 3.42]

- Circuit Analysis and Logic Design
- Embedded System Programming
- Machine Learning and IoT
- Microcontroller System and Interface Design

Skills:

Software: *Skilled* in Python, Linux, C/C++, Arduino Programming; *Experience* in Big Data Stack (Hadoop, Spark); *Experience* in Container Technology (Docker, Kubernetes)

Language:

Proficient in Cantonese, Mandarin; *Good command of* English

Activities:

Finspire Online Hackathon 2020;

SmarTone Hackathon 2019;

Hard@UST - Finalist;

Project STARS@PolyU – Gold Award

➢ *Couple Spending Companion*

➢ *Machine Learning assisted gesture recognition on Web using JS;*

➢ *Automatic Pizza making machine*

➢ *Cambodia, Myanmar Exchange;*

Experiences:

Engr Project Specialist I (Innovation Lab)/ Hewlett Packard Enterprise   *Jun 2020 - now*

- Container Technology: HPE Ezmeral Container Platform, Docker, Kubernetes;
- Big Data & Machine Learning Operation: HPE Ezmeral MLOps, HPE Ezmeral Data Fabric, Apache Spark;
- IoT & Edge Computing: HPE Edgeline, Apache Kafka;

Summer Intern / Wuxi Murata Electronics Co., Ltd   *Jul 2019 - Aug 2019*

- Developed RPA (Robot Process Automation) program for HR department;
- Understood the industrial process of manufacturing;

Summer Intern / Shenzhen Skyworth-RGB Electronic Co Ltd   *Jun 2019 - Jul 2019*

- Acquired knowledge about management of huge project (As Embedded Middleware Team);
- Acquired the proper program document writing and team management;

Electronic Engineer Trainee (Gap-Year Intern) / RF Tech Ltd   *Aug 2018 - May 2019*

- Developed product of LoRa, NB-IoT and Product Development for Visualization Platform;
- Manufactured PCB including Schematics, Layout and Soldering;
- Firmware programming on IoT system of Self-service Library Station;